DATA SHEET 74LVT00 3.3V Quad 2-input NAND gate **Product specification** 1996 Aug 15 WWW.DZSC.COM IC24 Data Handbook

INTEGRATED CIRCUITS







74LVT00

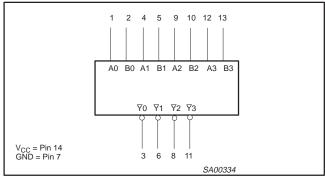
QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS T _{amb} = 25°C; GND = 0V	TYPICAL	UNIT
t _{PLH} t _{PHL}	Propagation delay An or Bn to Ȳn	C _L = 50pF; V _{CC} = 3.3V	2.7 2.7	ns
C _{IN}	Input capacitance	V ₁ = 0V or 3.0V	3	pF
ICCL	Total supply current	Outputs Low; $V_{CC} = 3.6V$	1	mA

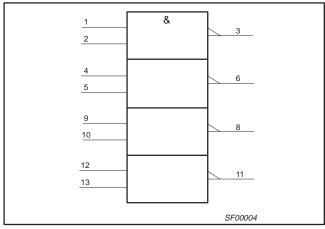
ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
14-Pin Plastic SO	–40°C to +85°C	74LVT00 D	74LVT00 D	SOT108-1
14-Pin Plastic SSOP	-40°C to +85°C	74LVT00 DB	74LVT00 DB	SOT337-1
14-Pin Plastic TSSOP	–40°C to +85°C	74LVT00 PW	74LVT00PW DH	SOT402-1

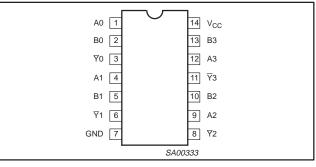
LOGIC SYMBOL



LOGIC SYMBOL (IEEE/IEC)



PIN CONFIGURATION

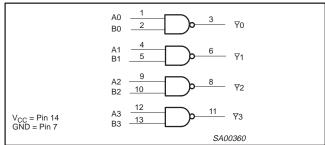


PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 2, 4, 5, 9, 10, 12, 13	An-Bn	Data inputs
3, 6, 8, 11	Ϋ́n	Data outputs
7	GND	Ground (0V)
14	V _{CC}	Positive supply voltage

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LOGIC DIAGRAM



FUNCTION TABLE

INPUTS		OUTPUT
Dna	Dnb	Qn
L	L	Н
L	Н	Н
Н	L	Н
Н	Н	L

NOTES:

H = High voltage level L = Low voltage level

ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +4.6	V
I _{IK}	DC input diode current	V ₁ < 0	-50	mA
VI	DC input voltage ³		-0.5 to +7.0	V
I _{OK}	DC output diode current	V _O < 0	-50	mA
V _{OUT}	DC output voltage ³	Output in Off or High state	-0.5 to +7.0	V
		Output in High state	-32	
IOUT	DC output current	Output in Low state	64	mA
T _{stg}	Storage temperature range		–65 to 150	°C

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction 2. temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

3. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		LIMITS	
STMBOL	FARAWETER	MIN	MAX	UNIT
V _{CC}	DC supply voltage	2.7	3.6	V
VI	Input voltage	0	5.5	V
V _{IH}	High-level input voltage			V
V _{IL}	Low-level Input voltage		0.8	V
I _{ОН}	High-level output current		-20	mA
I _{OL}	Low-level output current		32	mA
Δt/Δv	Input transition rise or fall rate; Outputs enabled		10	ns/V
T _{amb}	Operating free-air temperature range		+85	°C

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions Voltages are referenced to GND (ground = 0V)

	PARAMETER		LIMITS Temp = -40°C to +85°C			UNIT	
SYMBOL		TEST CONDITIONS					
			MIN	TYP ¹	MAX		
V _{IK}	Input clamp voltage	$V_{CC} = 2.7V; I_{IK} = -18mA$			-1.2	V	
		$V_{CC} = 2.7$ to 3.6V; $I_{OH} = -100\mu A$	V _{CC} -0.2				
V _{OH}	High-level output voltage	$V_{CC} = 2.7V; I_{OH} = -6mA$	2.4			V	
		$V_{CC} = 3.0V; I_{OH} = -20mA$	2.0			1	
		$V_{CC} = 2.7 V; I_{OL} = 100 \mu A$			0.2		
V _{OL}	Low-level output voltage	$V_{CC} = 2.7V; I_{OL} = 24mA$			0.5	V	
		$V_{CC} = 3.0V; I_{OL} = 32mA$			0.5		
Ŀ		$V_{CC} = 0 \text{ or } 3.6 \text{V}; \text{ V}_{\text{I}} = 5.5 \text{V}$			10		
11	Input leakage current	$V_{CC} = 3.6V; V_I = V_{CC} \text{ or } GND$			±1	μA	
I _{OFF}	Output off current	$V_{CC} = 0V; V_{I} \text{ or } V_{O} = 0 \text{ to } 4.5V$			±100	μΑ	
I _{ССН}		V_{CC} = 3.6V; Outputs High, V_{I} = GND or V_{CC} , I_{O} = 0			0.02	mA	
I _{CCL}	Quiescent supply current	V_{CC} = 3.6V; Outputs Low, V_{I} = GND or $V_{CC,}$ I_{O} = 0		1	2		
ΔI_{CC}	Additional supply current per input pin ²	V_{CC} = 3V to 3.6V; One input at V_{CC} -0.6V, Other inputs at V_{CC} or GND			0.2	μA	
CI	Input capacitance	$V_1 = 3V \text{ or } 0$		3		pF	

NOTES:

1. All typical values are at $V_{CC} = 3.3V$ and $T_{amb} = 25^{\circ}C$. 2. This is the increase in supply current for each input at the specificed voltage level other than V_{CC} or GND.

AC CHARACTERISTICS

GND = 0V; $t_R = t_F = 2.5ns$; $C_L = 50pF$, $R_L = 500\Omega$; $T_{amb} = -40^{\circ}C$ to +85°C.

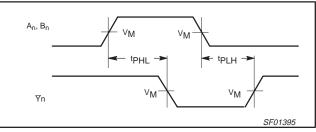
			LIMITS				
SYMBOL	PARAMETER	WAVEFORM	$V_{CC} = 3.3V \pm 0.3V$			$V_{CC} = 2.7 V$	UNIT
			MIN	TYP ¹	MAX	MAX	
t _{PLH} Propagation delay t _{PHL} An or Bn to Yn		1	1.0 1.0	2.7 2.7	4.1 3.9	5.0 3.8	ns

NOTE:

1. All typical values are at V_{CC} = 3.3V and T_{amb} = 25°C.

AC WAVEFORMS

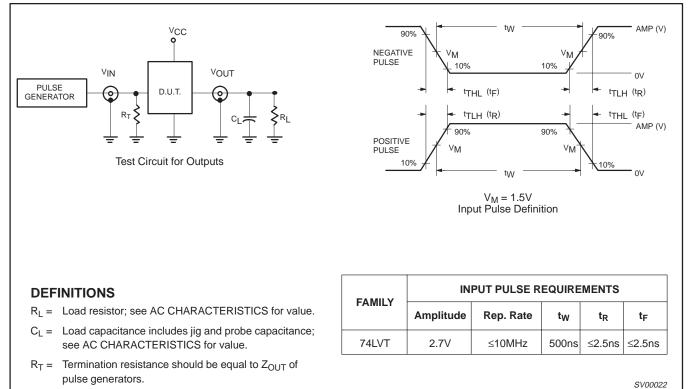
 V_{M} = 1.5V, V_{IN} = GND to 2.7V

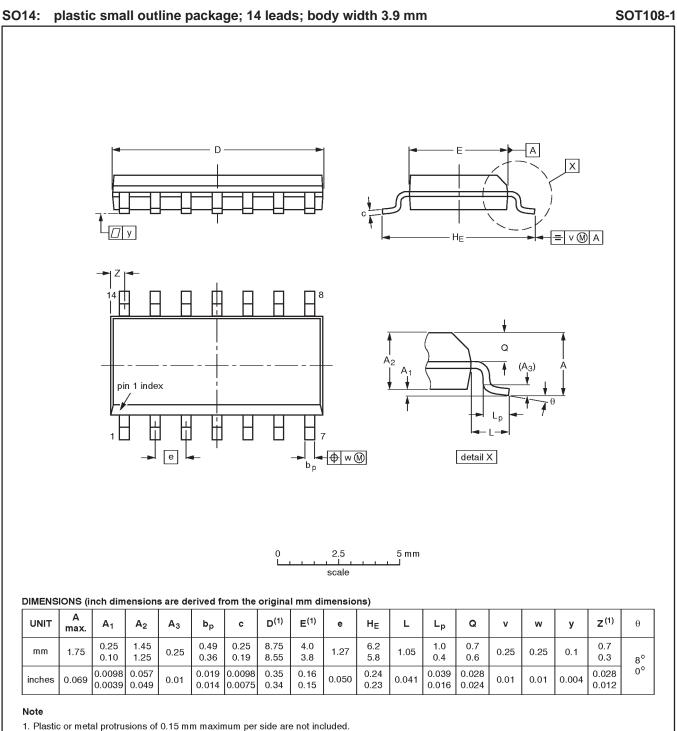


Waveform 1. Propagation delay for inverting outputs

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TEST CIRCUIT AND WAVEFORMS

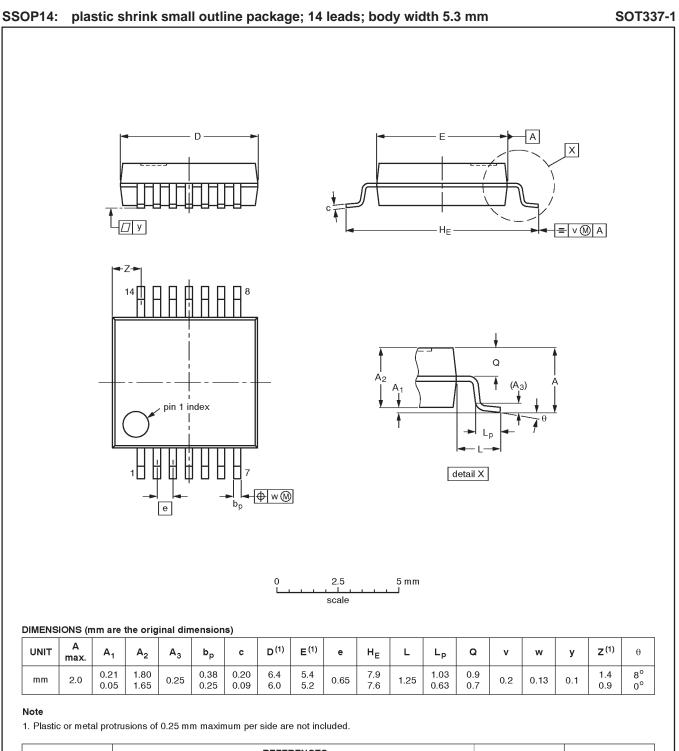




REFERENCES EUROPEAN OUTLINE ISSUE DATE PROJECTION VERSION IEC JEDEC EIAJ 91-08-13 \odot SOT108-1 076E06S MS-012AB F 95-01-23

Product specification

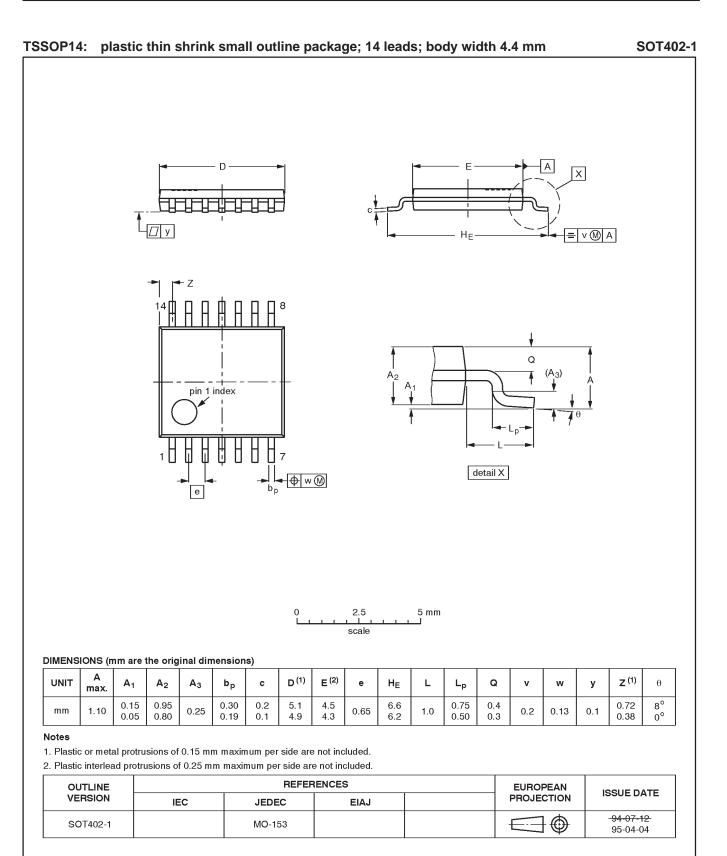
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Product specification

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NOTES

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DEFINITIONS				
Data Sheet Identification Product Status Definition				
Objective Specification Formative or in Design This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.				
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